

Features

- · High speed
 - $-t_{AA} = 9, 10, 12, 15, 20 \text{ ns}$
- · CMOS for optimum speed/power
- · Low active power
 - 965 mW (max.)
- · Automatic power-down when deselected
- Independent control of upper and lower bits
- Available in 44-pin TSOP II and 400-mil SOJ

Functional Description

The CY7C1021B is a high-performance CMOS static RAM organized as 65,536 words by 16 bits. This device has an automatic power-down feature that significantly reduces power consumption when deselected.

Writing to the device is accomplished by taking Chip Enable (CE) and Write Enable (WE) inputs LOW. If Byte Low Enable

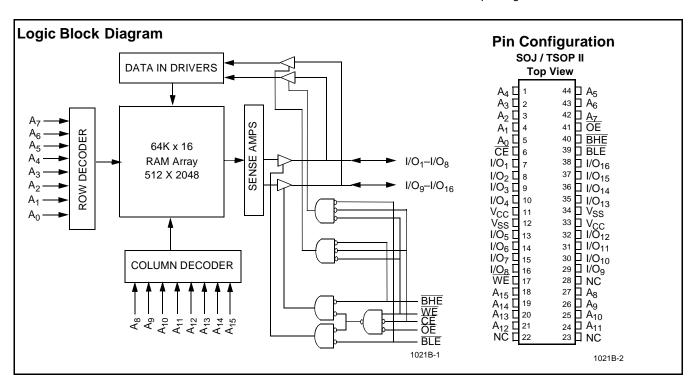
64K x 16 Static RAM

(BLE) is LOW, then data from I/O pins (I/O₁ through I/O₈), is written into the location specified on the address pins (A₀ through A₁₅). If Byte High Enable (BHE) is LOW, then data from I/O pins (I/O $_9$ through I/O $_{16}$) is written into the location specified on the address pins (A_0 through A_{15}).

Reading from the device is accomplished by taking Chip Enable (CE) and Output Enable (OE) LOW while forcing the Write Enable (WE) HIGH. If Byte Low Enable (BLE) is LOW, then data from the memory location specified by the address pins will appear on I/O₁ to I/O₈. If Byte High Enable (BHE) is LOW, then data from memory will appear on I/O₉ to I/O₁₆. See the truth table at the back of this data sheet for a complete description of read and write modes.

The input/output pins (I/O₁ through I/O₁₆) are placed in a high-impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), the BHE and BLE are disabled (BHE, BLE HIGH), or during a write operation (CE LOW, and WE LOW).

The CY7C1021B is available in standard 44-pin TSOP Type II and 400-mil-wide SOJ packages.



Selection Guide

		7C1021B-9	7C1021B-10	7C1021B-12	7C1021B-15	7C1021B-20
Maximum Access Time (ns)	Commercial	9	10	12	15	20
Maximum Operating Current (mA)	Commercial	175	150	140	130	120
Maximum CMOS Standby Current	Commercial	10	10	10	10	10
(mA)	L	0.5	0.5	0.5	0.5	0.5

Shaded areas contain preliminary information.



Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to +150°C Ambient Temperature with Power Applied-55°C to +125°C Supply Voltage on V_{CC} to Relative $GND^{[1]}$ –0.5V to +7.0V DC Voltage Applied to Outputs in High Z State^[1].....-0.5V to V_{CC}+0.5V DC Input Voltage^[1].....-0.5V to V_{CC}+0.5V

Current into Outputs (LOW)	20 mA
Static Discharge Voltage(per MIL-STD-883, Method 3015)	>2001V
Latch-Up Current	>200 mA

Operating Range

Range	Ambient Temperature ^[2]	V _{cc}
Commercial	0°C to +70°C	5V ± 10%
Industrial	-40°C to +85°C	5V ± 10%

Electrical Characteristics Over the Operating Range

		Test	Test 7C1021B-9		7C1021B-10 7C102		021B-12 7C10		7C1021B-15 7C1021B-20				
Parameter	Description	Conditions	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min.,$ $I_{OH} = -4.0 \text{ mA}$	2.4	2.4	2.4		2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	$V_{CC} = Min.,$ $I_{OL} = 8.0 \text{ mA}$		0.4		0.4		0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage		2.2	6.0	2.2	6.0	2.2	6.0	2.2	6.0	2.2	6.0	V
V _{IL}	Input LOW Voltage ^[1]		-0.5	0.5	-0.5	0.8	-0.5	0.8	-0.5	0.8	-0.5	0.8	V
I _{IX}	Input Load Current	$GND \le V_I \le V_C$	C -1	+1	-1	+1	-1	+1	-1	+1	-1	+1	μΑ
I _{OZ}	Output Leakage Current	GND ≤ V _I ≤ V _{C0} Output Disable		+1	-1	+1	-1	+1	-1	+1	-1	+1	μΑ
I _{OS}	Output Short Circuit Current ^[3]	V _{CC} = Max., V _{OUT} = GND	-300			-300		-300		-300		-300	mA
Icc	V _{CC} Operating Supply Current	$V_{CC} = Max.,$ $I_{OUT} = 0 \text{ mA},$ $f = f_{MAX} = 1/t_{RC}$	175			150		140		130		120	mA
I _{SB1}	AutomaticCE Power-Down Current —TTL Inputs	$\begin{split} & \underbrace{\text{Max. V}_{CC}}, \\ & \underbrace{\text{CE}} \geq V_{IH} \\ & V_{IN} \geq V_{IH} \text{ or } \\ & V_{IN} \leq V_{IL}, \\ & f = f_{MAX} \end{split}$	40			40		40		40		40	mA
I _{SB2}	AutomaticCE	Max. V _{CC} ,		10		10		10		10		10	mΑ
	Power-Down Current —CMOS Inputs	$CE \ge V_{CC} - 0.3V, V_{IN} \ge V_{CC} - 0.3V, Or V_{IN} \le 0.3V, f = 0$	-	0.5		0.5		0.5		0.5		0.5	mA

Shaded areas contain preliminary information.

Capacitance^[4]

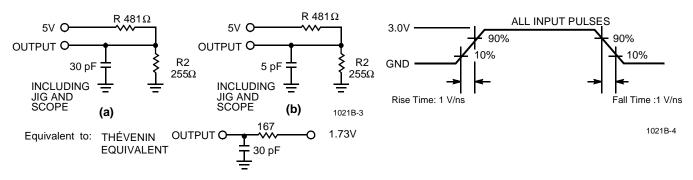
Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	8	pF
C _{OUT}	Output Capacitance	$V_{CC} = 5.0V$	8	pF

Notes:

- $V_{\rm IL}$ (min.) = -2.0V for pulse durations of less than 20 ns. $T_{\rm A}$ is the "Instant On" case temperature. Not more than one output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds. Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms



Switching Characteristics^[5] Over the Operating Range

		7C10	21B-9	7C1021B-10		7C1021B-12		7C1021B-15		7C1021B-20		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
READ CYC	LE										ı	
t _{RC}	Read Cycle Time	9		10		12		15		20		ns
t _{AA}	Address to Data Valid		9		10		12		15		20	ns
t _{OHA}	Data Hold from Address Change	3		3		3		3		3		ns
t _{ACE}	CE LOW to Data Valid		9		10		12		15		20	ns
t _{DOE}	OE LOW to Data Valid		5		5		6		7		9	ns
t _{LZOE}	OE LOW to Low Z ^[6]	0		0		0		0		0		ns
t _{HZOE}	OE HIGH to High Z ^[6, 7]		5		5		6		7		9	ns
t _{LZCE}	CE LOW to Low Z ^[6]	3		3		3		3		3		ns
t _{HZCE}	CE HIGH to High Z ^[6, 7]		5		5		6		7		9	ns
t _{PU}	CE LOW to Power-Up	0		0		0		0		0		ns
t _{PD}	CE HIGH to Power-Down		9		10		12		15		20	ns
t _{DBE}	Byte Enable to Data Valid		5		5		6		7		9	ns
t _{LZBE}	Byte Enable to Low Z	0		0		0		0		0		ns
t _{HZBE}	Byte Disable to High Z		5		5		6		7		9	ns
WRITE CYC	CLE ^[8]			•		•	•		•	•	•	
t _{WC}	Write Cycle Time	9		10		12		15		20		ns
t _{SCE}	CE LOW to Write End	8		8		9		10		12		ns
t _{AW}	Address Set-Up to Write End	7		7		8		10		12		ns
t _{HA}	Address Hold from Write End	0		0		0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		0		0		ns
t _{PWE}	WE Pulse Width	7		7		8		10		12		ns
t _{SD}	Data Set-Up to Write End	5		5		6		8		10		ns
t _{HD}	Data Hold from Write End	0		0		0		0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[6]	3		3		3		3		3		ns
t _{HZWE}	WE LOW to High Z ^[6, 7]		5		5		6		7		9	ns
t _{BW}	Byte Enable to End of Write	7		7		8		9		12		ns

Shaded areas contain preliminary information.

Notes:

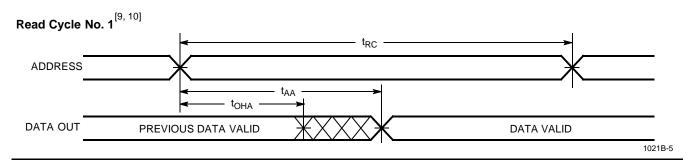
Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified 5.

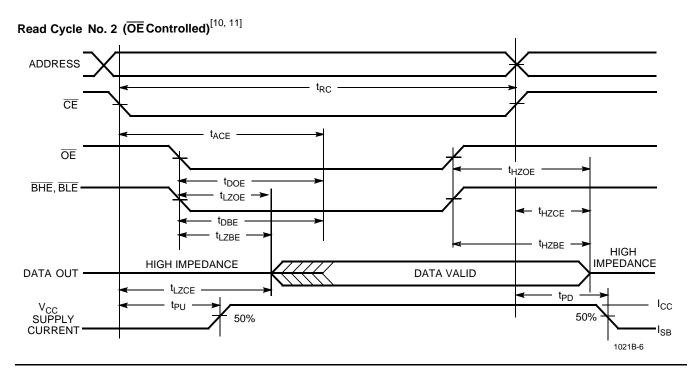
^{6.}

Item to find the signal transition time of 5 is oness, timing released of the signal transition time of 5 is oness, timing released of the signal part of 5 is oness, timing released of 5



Switching Waveforms





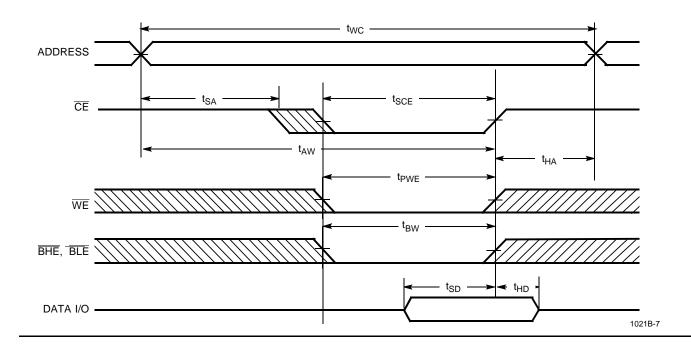
Notes:

- Device is continuously selected. OE, CE, BHE and/or BHE = V_{IL}.
 WE is HIGH for read cycle.
 Address valid prior to or coincident with CE transition LOW.

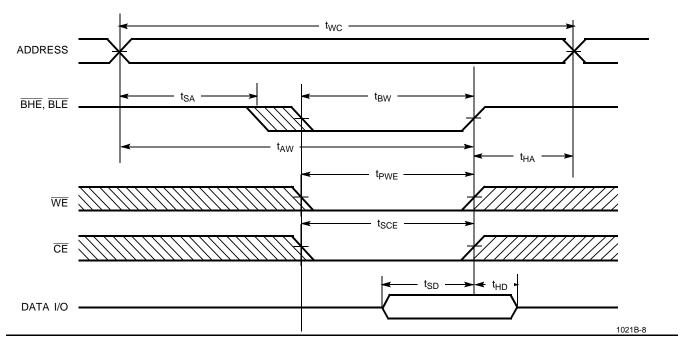


Switching Waveforms (continued)

Write Cycle No. 1 ($\overline{\text{CE}}$ Controlled) [12, 13]



Write Cycle No. 2 (BLE or BHE Controlled)

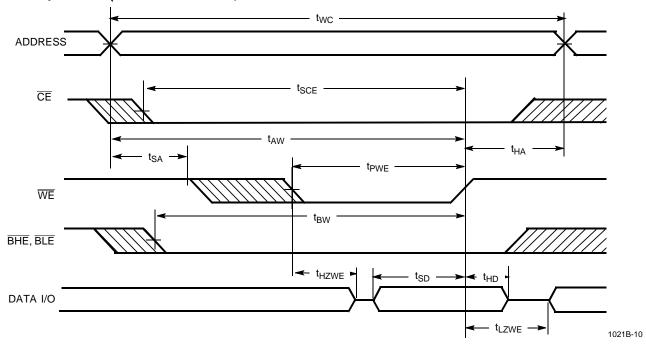


- Data I/O is high impedance if OE or BHE and/or BLE= V_{IH}.
 If CE goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.



Switching Waveforms (continued)

Write Cycle No. 3 (WE Controlled, LOW)



Truth Table

CE	OE	WE	BLE	BHE	I/O ₁ -I/O ₈	I/O ₉ -I/O ₁₆	Mode	Power
Н	Х	Х	Χ	Χ	High Z	High Z	Power-Down	Standby (I _{SB})
L	L	Н	L	L	Data Out	Data Out	Read - All bits	Active (I _{CC})
			L	Н	Data Out	High Z	Read - Lower bits only	Active (I _{CC})
			Н	L	High Z	Data Out	Read - Upper bits only	Active (I _{CC})
L	Х	L	L	L	Data In	Data In	Write - All bits	Active (I _{CC})
			L	Н	Data In	High Z	Write - Lower bits only	Active (I _{CC})
			Н	L	High Z	Data In	Write - Upper bits only	Active (I _{CC})
L	Н	Н	Χ	Χ	High Z	High Z	Selected, Outputs Disabled	Active (I _{CC})
L	Х	Х	Н	Н	High Z	High Z	Selected, Outputs Disabled	Active (I _{CC})



Ordering Information

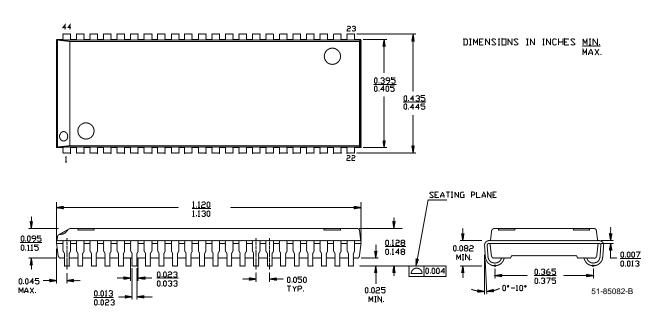
Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C1021B-10VC	V34	44-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1021B-10ZC	Z44	44-Lead TSOP Type II	Commercial
	CY7C1021BL-10ZC	Z44	44-Lead TSOP Type II	Commercial
12	CY7C1021B-12VC	V34	44-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1021B-12VI	V34	44-Lead (400-Mil) Molded SOJ	Industrial
	CY7C1021B-12ZC	Z44	44-Lead TSOP Type II	Commercial
15	CY7C1021B-15VC	V34	44-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1021B-15VI	V34	44-Lead (400-Mil) Molded SOJ	Industrial
	CY7C1021B-15ZC	Z44	44-Lead TSOP Type II	Commercial
	CY7C1021B-15ZI	Z44	44-Lead TSOP Type II	Industrial
	CY7C1021BL-15ZC	Z44	44-Lead TSOP Type II	Commercial
20	CY7C1021B-20VC	V34	44-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1021B-20ZC	Z44	44-Lead TSOP Type II	Commercial

Document #: 38-00951-*B



Package Diagrams

44-Lead (400-Mil) Molded SOJ V34





Package Diagrams (continued)

44-Pin TSOP II Z44

DIMENSION IN MM (INCH) MAX MIN.

